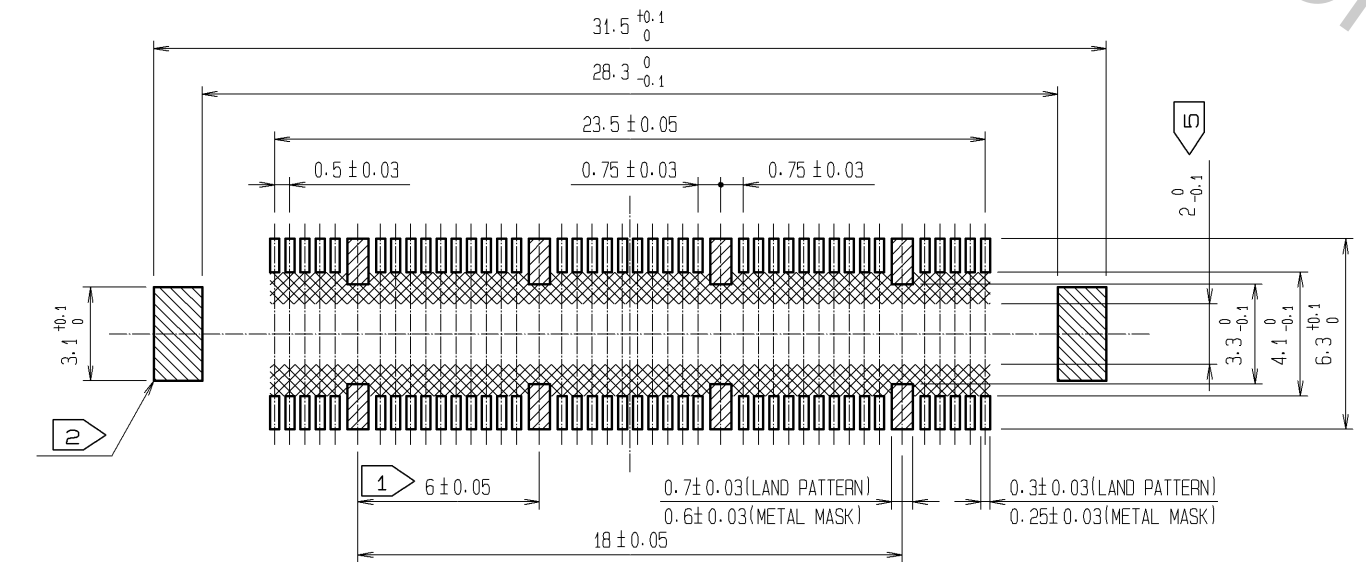


RECOMMENDED LAND PATTERN DIMENSION OF PCB



- NOTES
- ① 8 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

4	PHOSPHOR BRONZE	TIN-PLATING					
3	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1μm min.					
		LEAD AREA: TIN-PLATING 1μm min.					
2	PHOSPHOR BRONZE	TIN-PLATING					
1	LCP	BEIGE UL94V-0					
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS
UNITS		SCALE		COUNT		DESCRIPTION OF REVISIONS	
mm		4 : 1		△		DESIGNED	
						CHECKED	
						DATE	
APPROVED : HS. OKAWA				07.10.15		DRAWING NO. EDC3-151964-25	
CHECKED : HS. OZAWA				07.10.15		PART NO. FX10B-80P/8-SV1(71)	
DESIGNED : SY. KAMIGA				07.10.15		CODE NO. CL570-0121-7-71	
DRAWN : HK. SUNADORI				07.10.12			